

## FAST-TRANSIENT-RESPONSE 1-A LOW-DROPOUT VOLTAGE REGULATORS

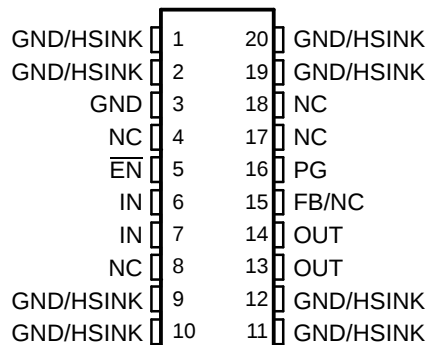
### FEATURES

- 1 A Low-Dropout Voltage Regulator
- Available in 1.5-V, 1.8-V, 2.5-V, 2.7-V, 2.8-V, 3.0-V, 3.3-V, 5.0-V Fixed Output and Adjustable Versions
- Dropout Voltage Down to 230 mV at 1 A (TPS76850)
- Ultralow 85  $\mu$ A Typical Quiescent Current
- Fast Transient Response
- 2% Tolerance Over Specified Conditions for Fixed-Output Versions
- Open Drain Power Good (See TPS767xx for Power-On Reset With 200-ms Delay Option)
- 8-Pin SOIC and 20-Pin TSSOP (PWP) Package
- Thermal Shutdown Protection

### DESCRIPTION

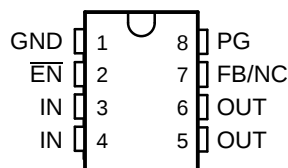
This device is designed to have a fast transient response and be stable with 10  $\mu$ F low ESR capacitors. This combination provides high performance at a reasonable cost.

PWP PACKAGE  
(TOP VIEW)

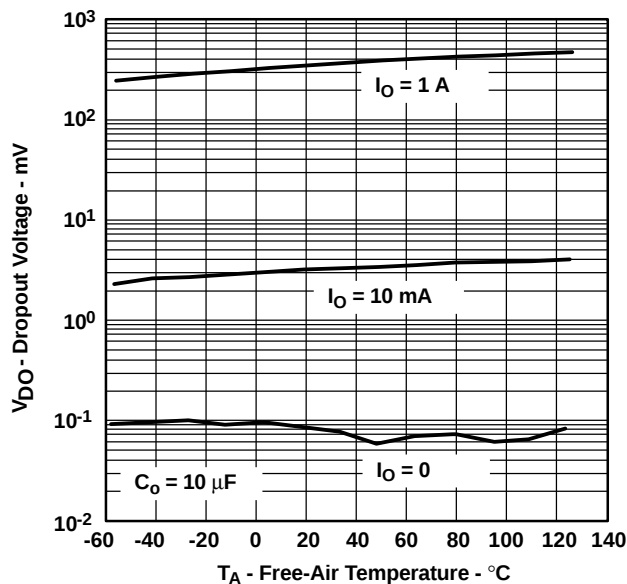


NC – No internal connection

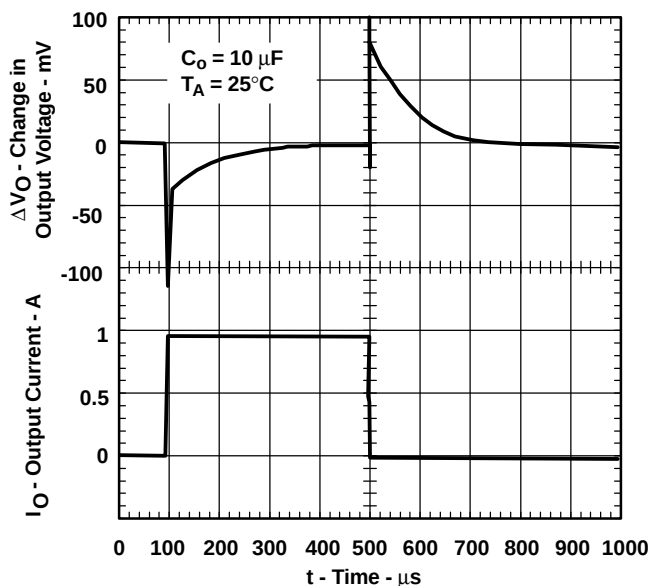
D PACKAGE  
(TOP VIEW)



TPS76833  
DROPOUT VOLTAGE  
VS  
FREE-AIR TEMPERATURE



LOAD TRANSIENT RESPONSE



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

## DESCRIPTION (CONTINUED)

Because the PMOS device behaves as a low-value resistor, the dropout voltage is very low (typically 230 mV at an output current of 1 A for the TPS76850) and is directly proportional to the output current. Additionally, since the PMOS pass element is a voltage-driven device, the quiescent current is very low and independent of output loading (typically 85  $\mu$ A over the full range of output current, 0 mA to 1 A). These two key specifications yield a significant improvement in operating life for battery-powered systems. This LDO family also features a sleep mode; applying a TTL high signal to  $\overline{\text{EN}}$  (enable) shuts down the regulator, reducing the quiescent current to less than 1  $\mu$ A at  $T_J = 25^\circ\text{C}$ .

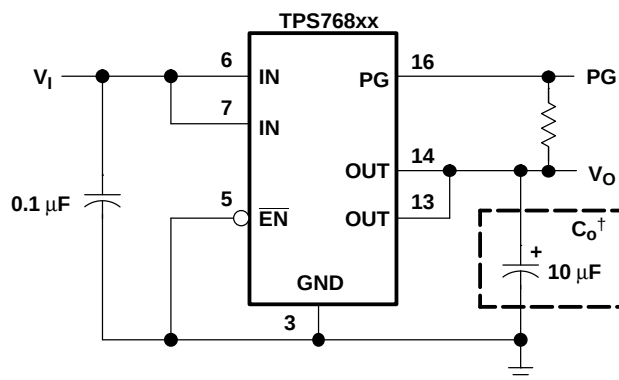
Power good (PG) is an active high output, which can be used to implement a power-on reset or a low-battery indicator.

The TPS768xx is offered in 1.5-V, 1.8-V, 2.5-V, 2.7-V, 2.8-V, 3.0-V, 3.3-V, and 5.0-V fixed-voltage versions and in an adjustable version (programmable over the range of 1.2 V to 5.5 V). Output voltage tolerance is specified as a maximum of 2% over line, load, and temperature ranges. The TPS768xx family is available in 8-pin SOIC and 20-pin PWP packages.

## AVAILABLE OPTIONS

| $T_J$         | OUTPUT VOLTAGE (V)        | PACKAGED DEVICES <sup>(1)</sup> |           |
|---------------|---------------------------|---------------------------------|-----------|
|               | TYP                       | TSSOP (PWP)                     | SOIC (D)  |
| 40°C to 125°C | 5.0                       | TPS76850Q                       | TPS76850Q |
|               | 3.3                       | TPS76833Q                       | TPS76833Q |
|               | 3.0                       | TPS76830Q                       | TPS76830Q |
|               | 2.8                       | TPS76828Q                       | TPS76828Q |
|               | 2.7                       | TPS76827Q                       | TPS76827Q |
|               | 2.5                       | TPS76825Q                       | TPS76825Q |
|               | 1.8                       | TPS76818Q                       | TPS76818Q |
|               | 1.5                       | TPS76815Q                       | TPS76815Q |
|               | Adjustable 1.2 V to 5.5 V | TPS76801Q                       | TPS76801Q |

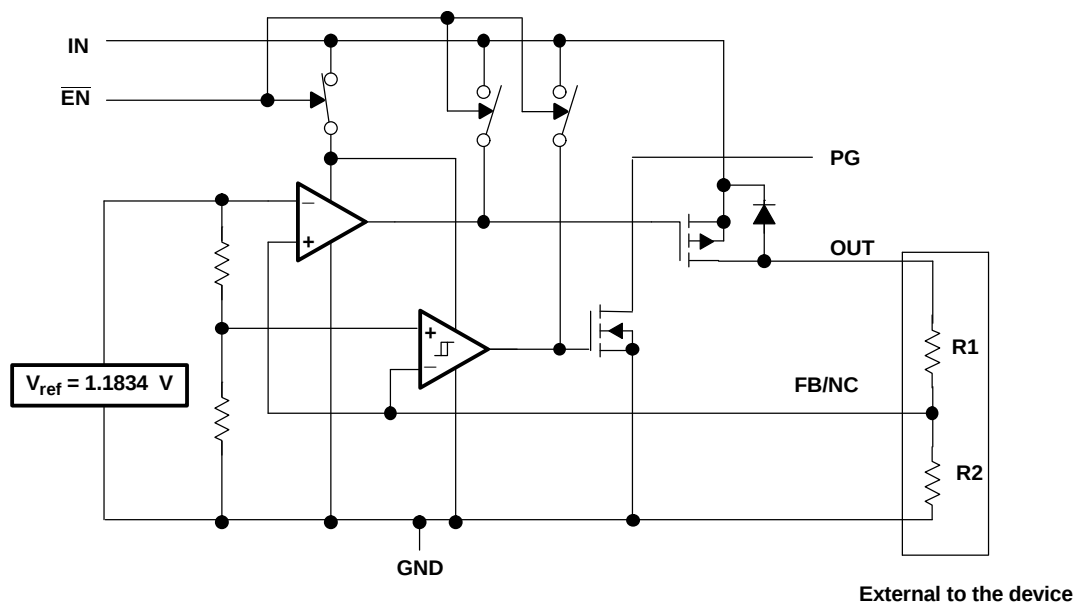
(1) The TPS76801 is programmable using an external resistor divider (see application information). The D and PWP packages are available taped and reeled. Add an R suffix to the device type (e.g., TPS76801QDR).



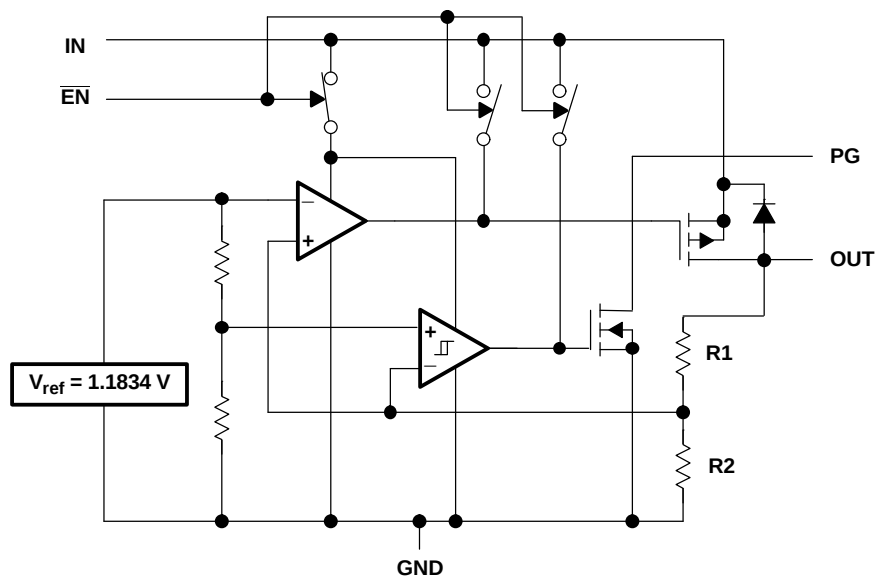
† See application information section for capacitor selection details.

**Figure 1. Typical Application Configuration (For Fixed Output Options)**

### FUNCTIONAL BLOCK DIAGRAM—Adjustable Version



### FUNCTIONAL BLOCK DIAGRAM—Fixed-Voltage Version



## Terminal Functions

| TERMINAL               |     | I/O | DESCRIPTION                                                                 |
|------------------------|-----|-----|-----------------------------------------------------------------------------|
| NAME                   | NO. |     |                                                                             |
| SOIC PACKAGE           |     |     |                                                                             |
| GND                    | 1   |     | Regulator ground                                                            |
| $\overline{\text{EN}}$ | 2   | I   | Enable input                                                                |
| IN                     | 3   | I   | Input voltage                                                               |
| IN                     | 4   | I   | Input voltage                                                               |
| OUT                    | 5   | O   | Regulated output voltage                                                    |
| OUT                    | 6   | O   | Regulated output voltage                                                    |
| FB/NC                  | 7   | I   | Feedback input voltage for adjustable device (no connect for fixed options) |
| PG                     | 8   | O   | PG output                                                                   |
| PWP PACKAGE            |     |     |                                                                             |
| GND/HSINK              | 1   |     | Ground/heatsink                                                             |
| GND/HSINK              | 2   |     | Ground/heatsink                                                             |
| GND                    | 3   |     | LDO ground                                                                  |
| NC                     | 4   |     | No connect                                                                  |
| $\overline{\text{EN}}$ | 5   | I   | Enable input                                                                |
| IN                     | 6   | I   | Input                                                                       |
| IN                     | 7   | I   | Input                                                                       |
| NC                     | 8   |     | No connect                                                                  |
| GND/HSINK              | 9   |     | Ground/heatsink                                                             |
| GND/HSINK              | 10  |     | Ground/heatsink                                                             |
| GND/HSINK              | 11  |     | Ground/heatsink                                                             |
| GND/HSINK              | 12  |     | Ground/heatsink                                                             |
| Out                    | 13  | O   | Regulated output voltage                                                    |
| Out                    | 14  | O   | Regulated output voltage                                                    |
| FB/NC                  | 15  | I   | Feedback input voltage for adjustable device (no connect for fixed options) |
| PG                     | 16  | O   | PG output                                                                   |
| NC                     | 17  |     | No connect                                                                  |
| NC                     | 18  |     | No connect                                                                  |
| GND/HSINK              | 19  |     | Ground/heatsink                                                             |
| GND/HSINK              | 20  |     | Ground/heatsink                                                             |



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                                             |                               |
|---------------------------------------------|-------------------------------|
| Input voltage range, $V_I$ <sup>(2)</sup>   | -0.3 V to 13.5 V              |
| Voltage range at $\overline{EN}$            | -0.3 V to $V_I + 0.3$ V       |
| Maximum PG voltage                          | 16.5 V                        |
| Peak output current                         | Internally limited            |
| Continuous total power dissipation          | See dissipation rating tables |
| Output voltage, $V_O$ (OUT, FB)             | 7 V                           |
| Operating junction temperature range, $T_J$ | -40°C to 125°C                |
| Storage temperature range, $T_{stg}$        | -65°C to 150°C                |
| ESD rating, HBM                             | 2 kV                          |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network terminal ground.

## DISSIPATION RATING TABLE 1 - FREE-AIR TEMPERATURES

| PACKAGE | AIR FLOW (CFM) | $T_A < 25^\circ\text{C}$ POWER RATING | DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$ | $T_A = 70^\circ\text{C}$ POWER RATING | $T_A = 85^\circ\text{C}$ POWER RATING |
|---------|----------------|---------------------------------------|------------------------------------------------|---------------------------------------|---------------------------------------|
| D       | 0              | 568.18 mW                             | 5.6818 mW/°C                                   | 312.5 mW                              | 227.27 mW                             |
|         | 250            | 904.15 mW                             | 9.0415 mW/°C                                   | 497.28 mW                             | 361.66 mW                             |

## DISSIPATION RATING TABLE 2 - FREE-AIR TEMPERATURES

| PACKAGE            | AIR FLOW (CFM) | $T_A < 25^\circ\text{C}$ POWER RATING | DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$ | $T_A = 70^\circ\text{C}$ POWER RATING | $T_A = 85^\circ\text{C}$ POWER RATING |
|--------------------|----------------|---------------------------------------|------------------------------------------------|---------------------------------------|---------------------------------------|
| PWP <sup>(1)</sup> | 0              | 2.9 W                                 | 23.5 mW/°C                                     | 1.9 W                                 | 1.5 W                                 |
|                    | 300            | 4.3 W                                 | 34.6 mW/°C                                     | 2.8 W                                 | 2.2 W                                 |
| PWP <sup>(2)</sup> | 0              | 3 W                                   | 23.8 mW/°C                                     | 1.9 W                                 | 1.5 W                                 |
|                    | 300            | 7.2 W                                 | 57.9 mW/°C                                     | 4.6 W                                 | 3.8 W                                 |

- (1) This parameter is measured with the recommended copper heat sink pattern on a 1-layer PCB, 5-in x 5-in PCB, 1 oz. copper, 2-in x 2-in coverage (4 in<sup>2</sup>).
- (2) This parameter is measured with the recommended copper heat sink pattern on an 8-layer PCB, 1.5-in x 2-in PCB, 1 oz. copper, with layers 1, 2, 3, 4, 5, 7, and 8 at 5% coverage (0.9 in<sup>2</sup>) and layers 3 and 6 at 100% coverage (6 in<sup>2</sup>). For more information, refer to TI technical brief SLMA002, available for download at [www.ti.com](http://www.ti.com).

## RECOMMENDED OPERATING CONDITIONS

|                                                      | MIN | MAX | UNIT |
|------------------------------------------------------|-----|-----|------|
| Input voltage, $V_I$ <sup>(1)</sup>                  | 2.7 | 10  | V    |
| Output voltage range, $V_O$                          | 1.2 | 5.5 | V    |
| Output current, $I_O$ <sup>(2)</sup>                 | 0   | 1.0 | A    |
| Operating junction temperature, $T_J$ <sup>(2)</sup> | 40  | 125 | °C   |

- (1) To calculate the minimum input voltage for your maximum output current, use the following equation:  $V_{I(\min)} = V_{O(\max)} + V_{DO(\max \text{ load})}$ .
- (2) Continuous current and operating junction temperature are limited by internal protection circuitry, but it is not recommended that the device operate under conditions beyond those specified in this table for extended periods of time.

## ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range,  $V_I = V_{O(\text{typ})} + 1 \text{ V}$ ,  $I_O = 1 \text{ mA}$ ,  $\overline{\text{EN}} = 0 \text{ V}$ ,  $C_O = 10 \mu\text{F}$  (unless otherwise noted)

| PARAMETER                                                                           |                                    | TEST CONDITIONS                                                                                          | MIN                                               | TYP                | MAX | UNIT  |     |                 |
|-------------------------------------------------------------------------------------|------------------------------------|----------------------------------------------------------------------------------------------------------|---------------------------------------------------|--------------------|-----|-------|-----|-----------------|
| Output voltage (10 μA to 1 A load) <sup>(1)</sup>                                   | TPS76801                           | 5.5 V ≥ V <sub>O</sub> ≥ 1.5 V, T <sub>J</sub> = 25°C                                                    | V <sub>O</sub>                                    |                    |     | V     |     |                 |
|                                                                                     |                                    | 5.5 V ≥ V <sub>O</sub> ≥ 1.5 V, T <sub>J</sub> = -40°C to 125°C                                          | 0.98V <sub>O</sub>                                | 1.02V <sub>O</sub> |     |       |     |                 |
|                                                                                     | TPS76815                           | T <sub>J</sub> = 25°C, 2.7 V < V <sub>IN</sub> < 10 V                                                    | 1.5                                               |                    |     |       |     |                 |
|                                                                                     |                                    | T <sub>J</sub> = -40°C to 125°C, 2.7 V < V <sub>IN</sub> < 10 V                                          | 1.470                                             | 1.530              |     |       |     |                 |
|                                                                                     | TPS76818                           | T <sub>J</sub> = 25°C, 2.8 V < V <sub>IN</sub> < 10 V                                                    | 1.8                                               |                    |     |       |     |                 |
|                                                                                     |                                    | T <sub>J</sub> = -40°C to 125°C, 2.8 V < V <sub>IN</sub> < 10 V                                          | 1.764                                             | 1.836              |     |       |     |                 |
|                                                                                     | TPS76825                           | T <sub>J</sub> = 25°C, 3.5 V < V <sub>IN</sub> < 10 V                                                    | 2.5                                               |                    |     |       |     |                 |
|                                                                                     |                                    | T <sub>J</sub> = -40°C to 125°C, 3.5 V < V <sub>IN</sub> < 10 V                                          | 2.450                                             | 2.550              |     |       |     |                 |
|                                                                                     | TPS76827                           | T <sub>J</sub> = 25°C, 3.7 V < V <sub>IN</sub> < 10 V                                                    | 2.7                                               |                    |     |       |     |                 |
|                                                                                     |                                    | T <sub>J</sub> = -40°C to 125°C, 3.7 V < V <sub>IN</sub> < 10 V                                          | 2.646                                             | 2.754              |     |       |     |                 |
|                                                                                     | TPS76828                           | T <sub>J</sub> = 25°C, 3.8 V < V <sub>IN</sub> < 10 V                                                    | 2.8                                               |                    |     |       |     |                 |
|                                                                                     |                                    | T <sub>J</sub> = -40°C to 125°C, 3.8 V < V <sub>IN</sub> < 10 V                                          | 2.744                                             | 2.856              |     |       |     |                 |
|                                                                                     | TPS76830                           | T <sub>J</sub> = 25°C, 4 V < V <sub>IN</sub> < 10 V                                                      | 3.0                                               |                    |     |       |     |                 |
|                                                                                     |                                    | T <sub>J</sub> = -40°C to 125°C, 4 V < V <sub>IN</sub> < 10 V                                            | 2.940                                             | 3.060              |     |       |     |                 |
|                                                                                     | TPS76833                           | T <sub>J</sub> = 25°C, 4.3 V < V <sub>IN</sub> < 10 V                                                    | 3.3                                               |                    |     |       |     |                 |
|                                                                                     |                                    | T <sub>J</sub> = -40°C to 125°C, 4.3 V < V <sub>IN</sub> < 10 V                                          | 3.234                                             | 3.366              |     |       |     |                 |
|                                                                                     | TPS76850                           | T <sub>J</sub> = 25°C, 6 V < V <sub>IN</sub> < 10 V                                                      | 5.0                                               |                    |     |       |     |                 |
|                                                                                     |                                    | T <sub>J</sub> = -40°C to 125°C, 6 V < V <sub>IN</sub> < 10 V                                            | 4.900                                             | 5.100              |     |       |     |                 |
| Quiescent current (GND current) $\overline{\text{EN}}$ = 0V <sup>(1)</sup>          |                                    | 10 μA < I <sub>O</sub> < 1 A, T <sub>J</sub> = 25°C                                                      | 85                                                |                    |     | μA    |     |                 |
|                                                                                     |                                    | I <sub>O</sub> = 1 A, T <sub>J</sub> = -40°C to 125°C                                                    | 125                                               |                    |     |       |     |                 |
| Output voltage line regulation (ΔV <sub>O</sub> /V <sub>O</sub> ) <sup>(1)(2)</sup> |                                    | V <sub>O</sub> + 1 V < V <sub>I</sub> ≤ 10 V, T <sub>J</sub> = 25°C                                      | 0.01                                              |                    |     | %/V   |     |                 |
| Load regulation                                                                     |                                    |                                                                                                          | 3                                                 |                    |     | mV    |     |                 |
| Output noise voltage (TPS76818)                                                     |                                    | BW = 200 Hz to 100 kHz, C <sub>o</sub> = 10 μF, I <sub>C</sub> = 1 A, T <sub>J</sub> = 25°C              | 55                                                |                    |     | μVrms |     |                 |
| Output current limit                                                                |                                    | V <sub>O</sub> = 0 V                                                                                     | 1.2                                               | 1.7                | 2   | A     |     |                 |
| Thermal shutdown junction temperature                                               |                                    |                                                                                                          | 150                                               |                    |     | °C    |     |                 |
| Standby current                                                                     |                                    | $\overline{\text{EN}}$ = V <sub>I</sub> , T <sub>J</sub> = 25°C, 2.7 V < V <sub>I</sub> < 10 V           | 1                                                 |                    |     | μA    |     |                 |
|                                                                                     |                                    | $\overline{\text{EN}}$ = V <sub>I</sub> , T <sub>J</sub> = -40°C to 125°C, 2.7 V < V <sub>I</sub> < 10 V | 10                                                |                    |     | μA    |     |                 |
| FB input current                                                                    | TPS76801                           | FB = 1.5 V                                                                                               | 2                                                 |                    |     | nA    |     |                 |
| High level enable input voltage                                                     |                                    |                                                                                                          | 1.7                                               |                    |     | V     |     |                 |
| Low level enable input voltage                                                      |                                    |                                                                                                          | 0.9                                               |                    |     | V     |     |                 |
| Power supply ripple rejection <sup>(1)</sup>                                        |                                    | f = 1 KHz, C <sub>o</sub> = 10 μF, T <sub>J</sub> = 25°C                                                 | 60                                                |                    |     | dB    |     |                 |
| PG                                                                                  | Minimum input voltage for valid PG |                                                                                                          | I <sub>O(PG)</sub> = 300 μA                       |                    |     | V     |     |                 |
|                                                                                     | Trip threshold voltage             |                                                                                                          | V <sub>O</sub> decreasing                         |                    |     | 92    | 98  | %V <sub>O</sub> |
|                                                                                     | Hysteresis voltage                 |                                                                                                          | Measured at V <sub>O</sub>                        |                    |     | 0.5   |     | %V <sub>O</sub> |
|                                                                                     | Output low voltage                 |                                                                                                          | V <sub>I</sub> = 2.7 V, I <sub>O(PG)</sub> = 1 mA |                    |     | 0.15  | 0.4 | V               |
|                                                                                     | Leakage current                    |                                                                                                          | V <sub>(PG)</sub> = 5 V                           |                    |     | 1     |     | μA              |

(1) Minimum IN operating voltage is 2.7 V or  $V_{O(\text{typ})} + 1 \text{ V}$ , whichever is greater. Maximum IN voltage 10 V.

(2) If  $V_O \leq 1.8 \text{ V}$  then  $V_{\text{Imax}} = 10 \text{ V}$ ,  $V_{\text{Imin}} = 2.7 \text{ V}$ :  $\text{Line Reg. (mV)} = (\% / \text{V}) \times V_O \frac{(V_{\text{Imax}} - 2.7 \text{ V})}{100} \times 1000$   
 If  $V_O \geq 2.5 \text{ V}$  then  $V_{\text{Imax}} = 10 \text{ V}$ ,  $V_{\text{Imin}} = V_O + 1 \text{ V}$ :  $\text{Line Reg. (mV)} = (\% / \text{V}) \times V_O \frac{(V_{\text{Imax}} - (V_O + 1 \text{ V}))}{100} \times 1000$

## ELECTRICAL CHARACTERISTICS (continued)

over recommended operating free-air temperature range,  $V_I = V_{O(typ)} + 1\text{ V}$ ,  $I_O = 1\text{ mA}$ ,  $\overline{EN} = 0\text{ V}$ ,  $C_O = 10\text{ }\mu\text{F}$  (unless otherwise noted)

| PARAMETER                         |          | TEST CONDITIONS                                                       | MIN | TYP | MAX | UNIT          |
|-----------------------------------|----------|-----------------------------------------------------------------------|-----|-----|-----|---------------|
| Input current ( $\overline{EN}$ ) |          | $\overline{EN} = 0\text{ V}$                                          | 1   | 0   | 1   | $\mu\text{A}$ |
|                                   |          | $\overline{EN} = V_I$                                                 | 1   |     | 1   |               |
| Dropout voltage <sup>(3)</sup>    | TPS76828 | $I_O = 1\text{ A}$ , $T_J = 25^\circ\text{C}$                         |     | 500 |     | mV            |
|                                   |          | $I_O = 1\text{ A}$ , $T_J = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 825 |               |
|                                   | TPS76830 | $I_O = 1\text{ A}$ , $T_J = 25^\circ\text{C}$                         |     | 450 |     |               |
|                                   |          | $I_O = 1\text{ A}$ , $T_J = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 675 |               |
|                                   | TPS76833 | $I_O = 1\text{ A}$ , $T_J = 25^\circ\text{C}$                         |     | 350 |     |               |
|                                   |          | $I_O = 1\text{ A}$ , $T_J = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 575 |               |
|                                   | TPS76850 | $I_O = 1\text{ A}$ , $T_J = 25^\circ\text{C}$                         |     | 230 |     |               |
|                                   |          | $I_O = 1\text{ A}$ , $T_J = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 380 |     |               |

(3)  $I_N$  voltage equals  $V_{O(typ)} - 100\text{ mV}$ ; TPS76801 output voltage set to 3.3 V nominal with external resistor divider. TPS76815, TPS76818, TPS76825, and TPS76827 dropout voltage limited by input voltage range limitations (i.e., TPS76830 input voltage needs to drop to 2.9 V for purpose of this test).

## Table of Graphs

|          |                                    |                         | FIGURE  |
|----------|------------------------------------|-------------------------|---------|
| $V_O$    | Output voltage                     | vs Output current       | 2, 3, 4 |
|          |                                    | vs Free-air temperature | 5, 6, 7 |
|          | Ground current                     | vs Free-air temperature | 8, 9    |
|          | Power supply ripple rejection      | vs Frequency            | 10      |
|          | Output spectral noise density      | vs Frequency            | 11      |
|          | Input voltage (min)                | vs Output voltage       | 12      |
| $Z_O$    | Output impedance                   | vs Frequency            | 13      |
| $V_{DO}$ | Dropout voltage                    | vs Free-air temperature | 14      |
|          | Line transient response            |                         | 15, 17  |
|          | Load transient response            |                         | 16, 18  |
| $V_O$    | Output voltage                     | vs Time                 | 19      |
|          | Dropout voltage                    | vs Input voltage        | 20      |
|          | Equivalent series resistance (ESR) | vs Output current       | 22 - 25 |

## TYPICAL CHARACTERISTICS

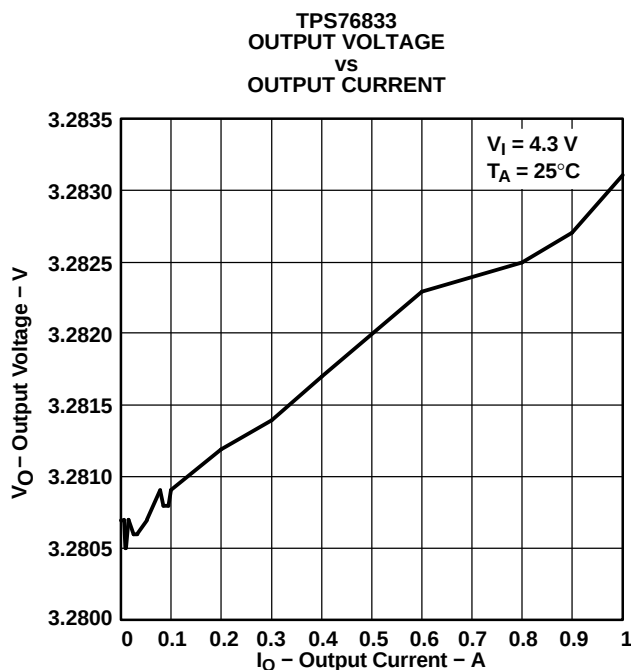


Figure 2.

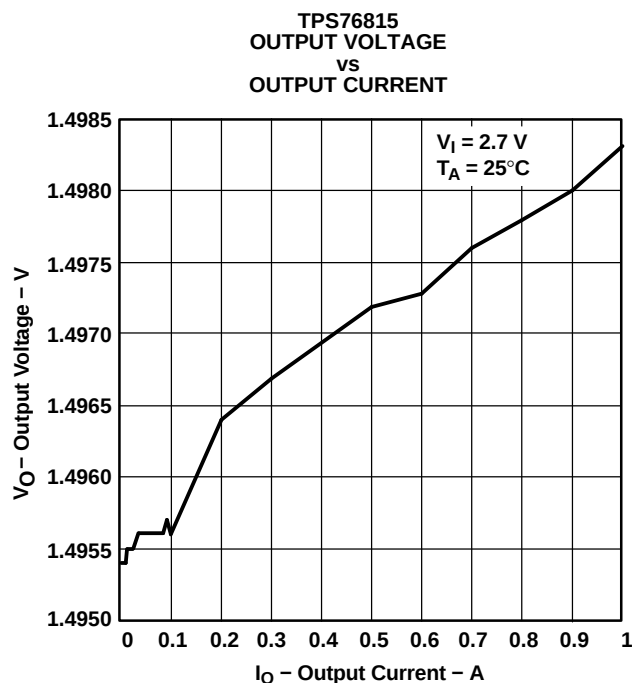


Figure 3.

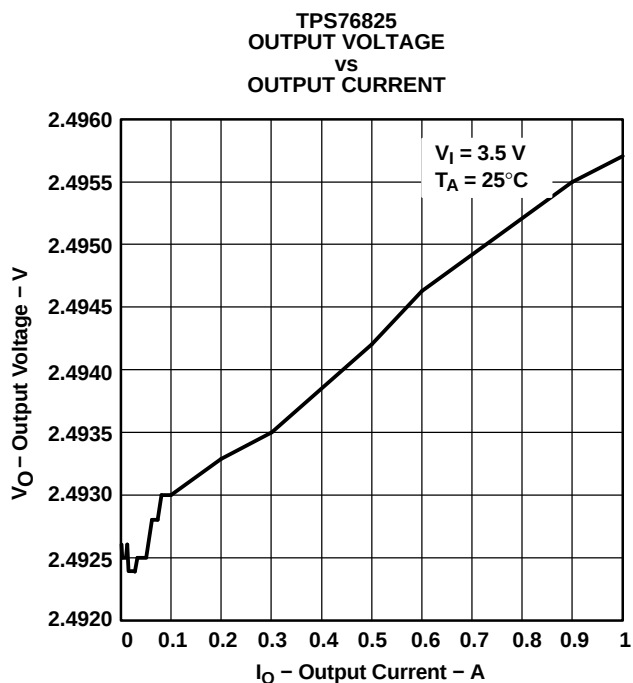


Figure 4.

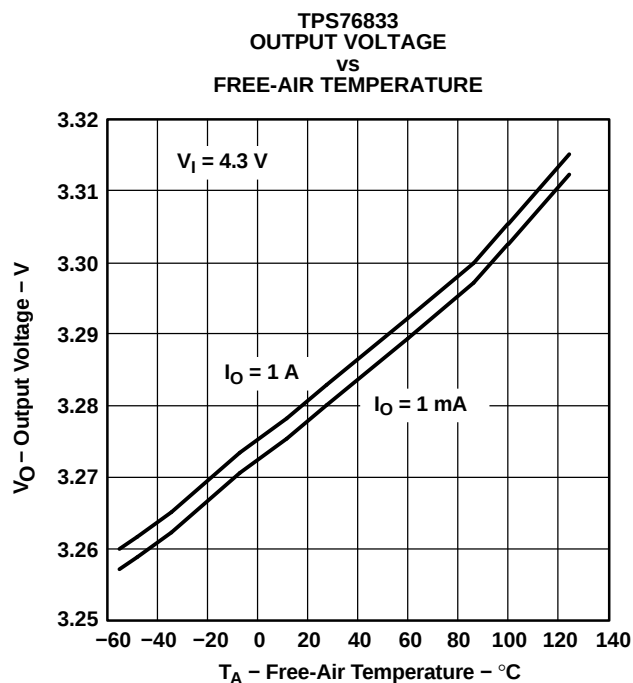


Figure 5.

## TYPICAL CHARACTERISTICS (continued)

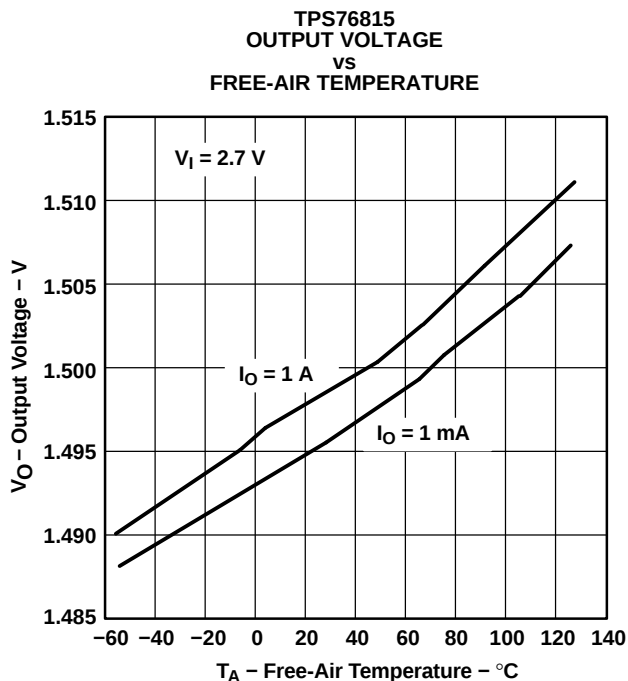


Figure 6.

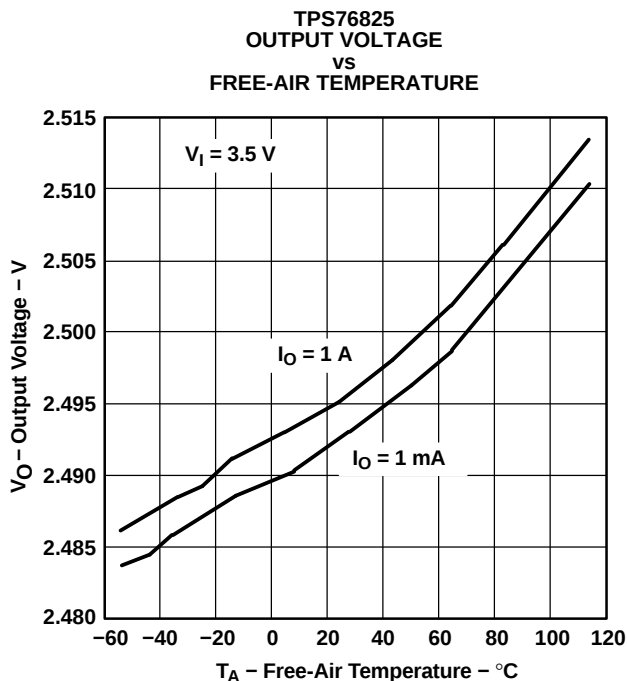


Figure 7.

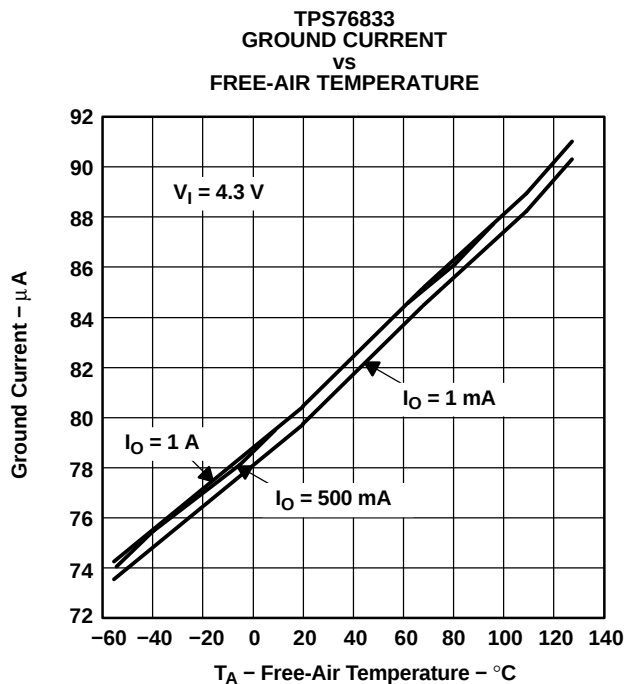


Figure 8.

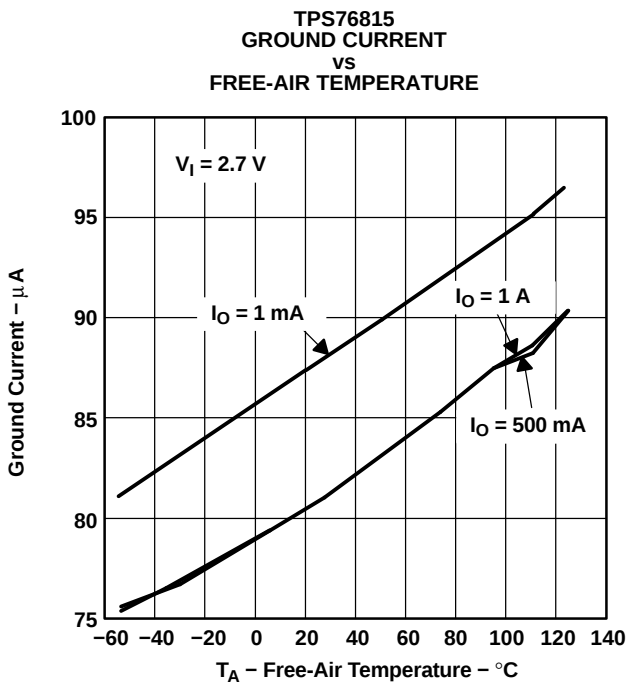


Figure 9.

# TYPICAL CHARACTERISTICS (continued)

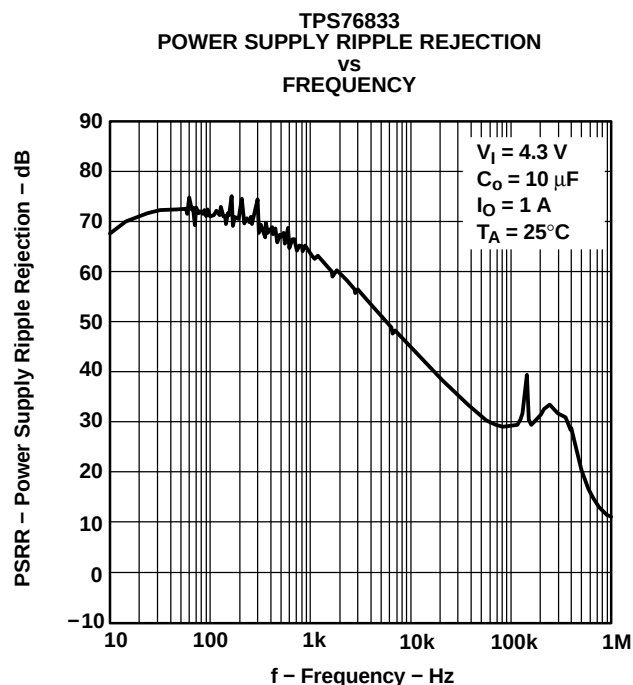


Figure 10.

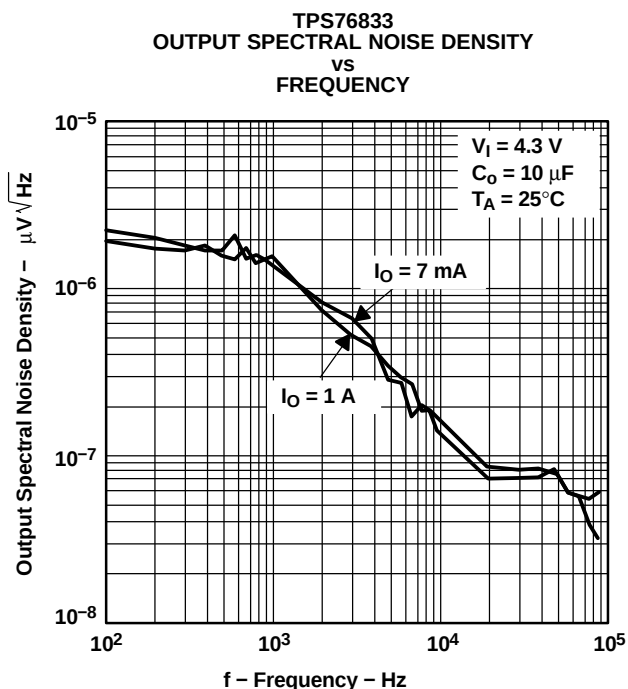


Figure 11.

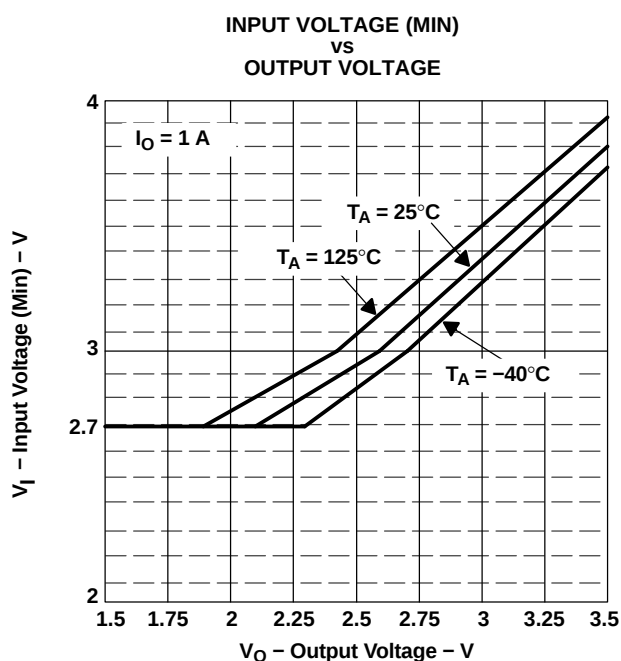


Figure 12.

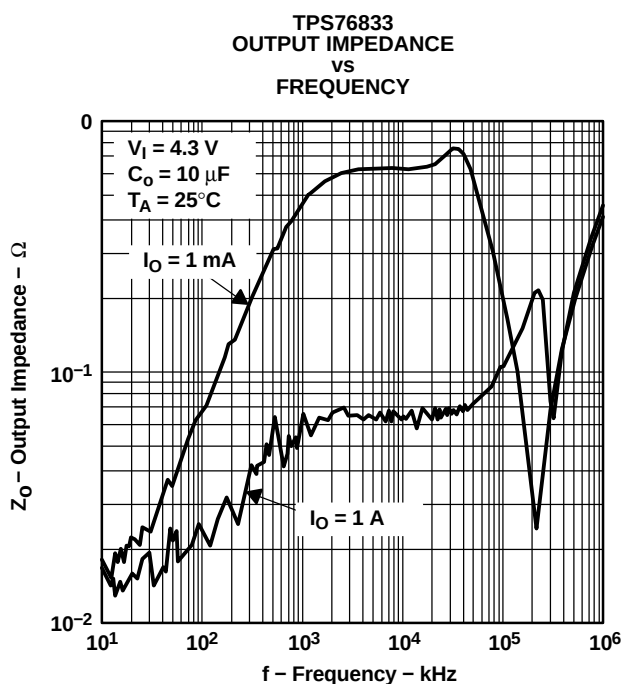


Figure 13.

## TYPICAL CHARACTERISTICS (continued)

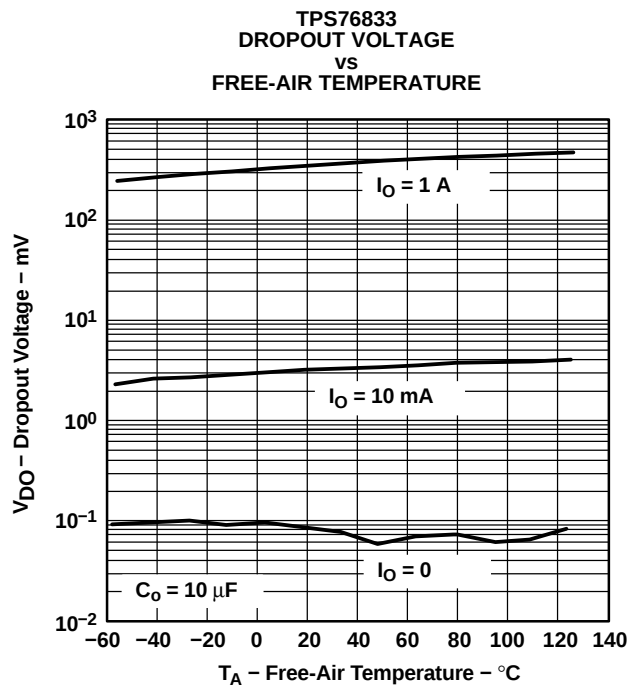


Figure 14.

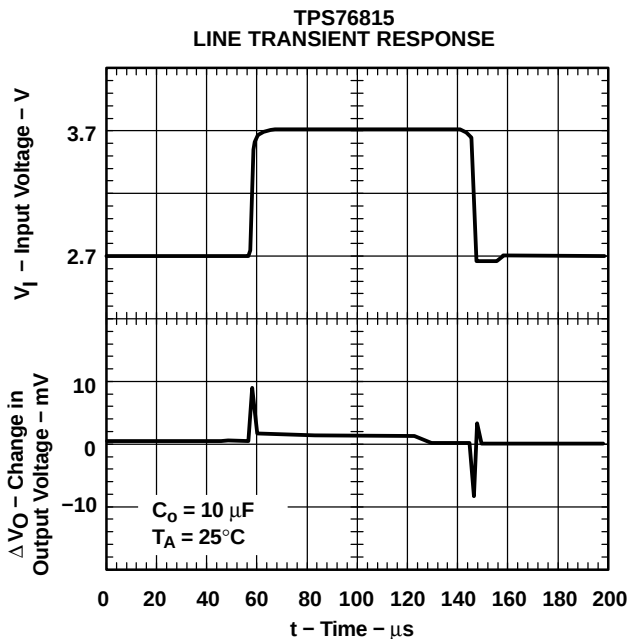


Figure 15.

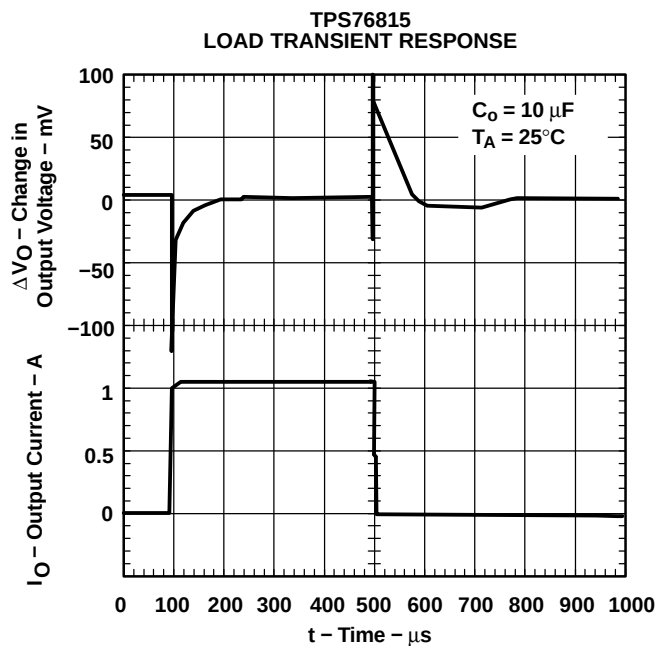


Figure 16.

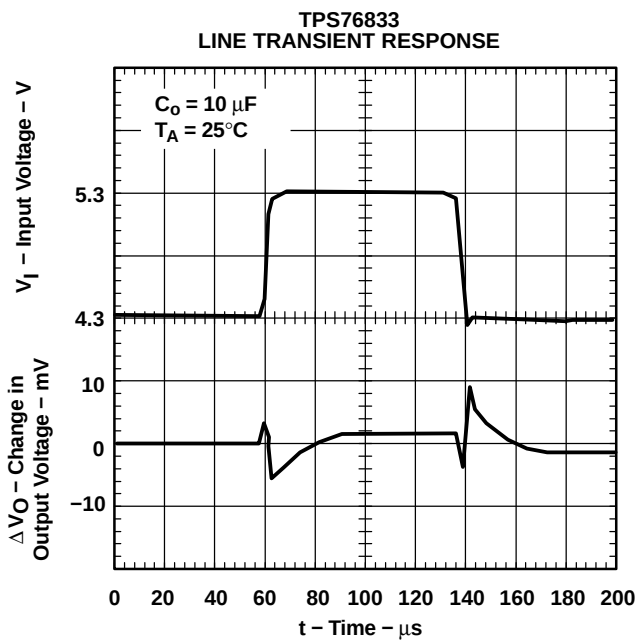


Figure 17.

## TYPICAL CHARACTERISTICS (continued)

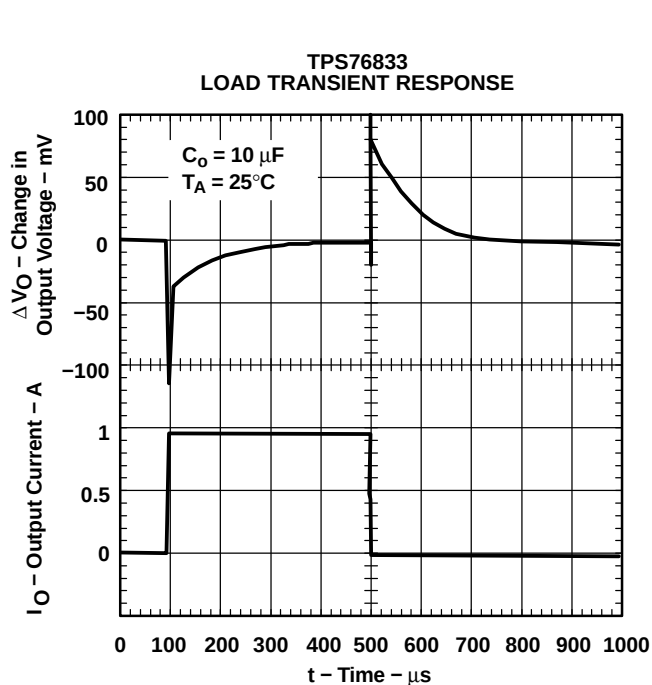


Figure 18.

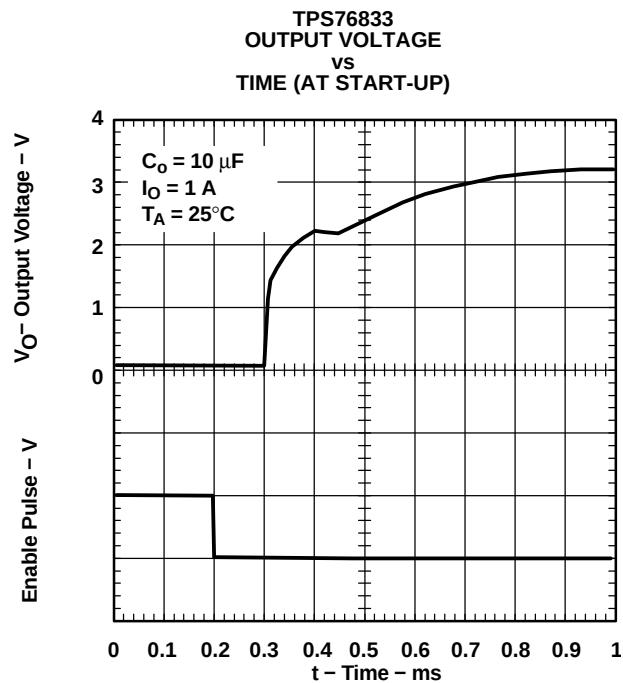


Figure 19.

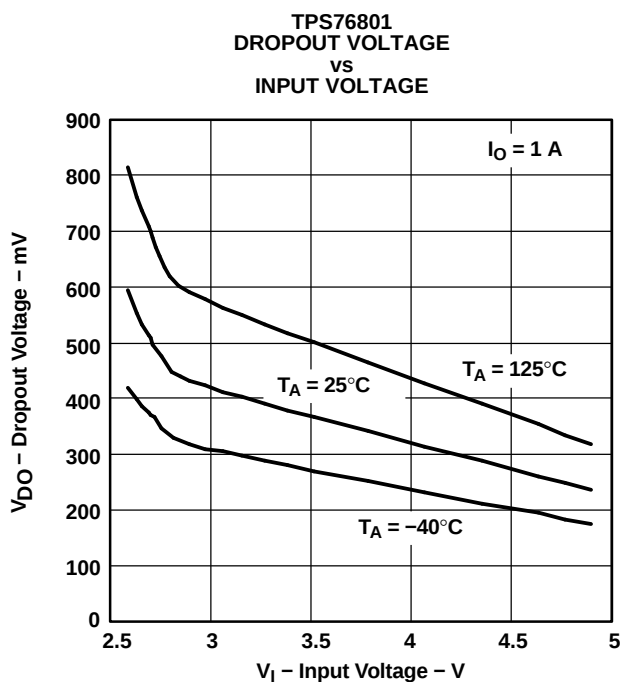


Figure 20.

## TYPICAL CHARACTERISTICS (continued)

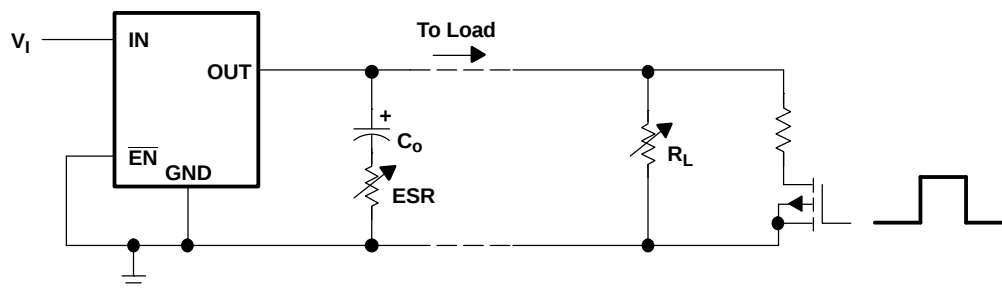


Figure 21. Test Circuit for Typical Regions of Stability (Figure 22 through Figure 25)  
(Fixed Output Options)

Equivalent series resistance (ESR) refers to the total series resistance, including the ESR of the capacitor, any series resistance added externally, and PWB trace resistance to  $C_O$ .

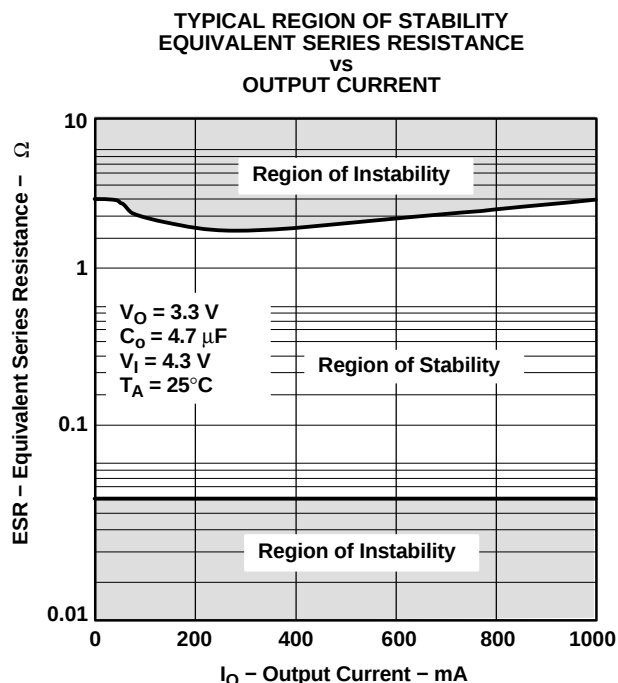


Figure 22.

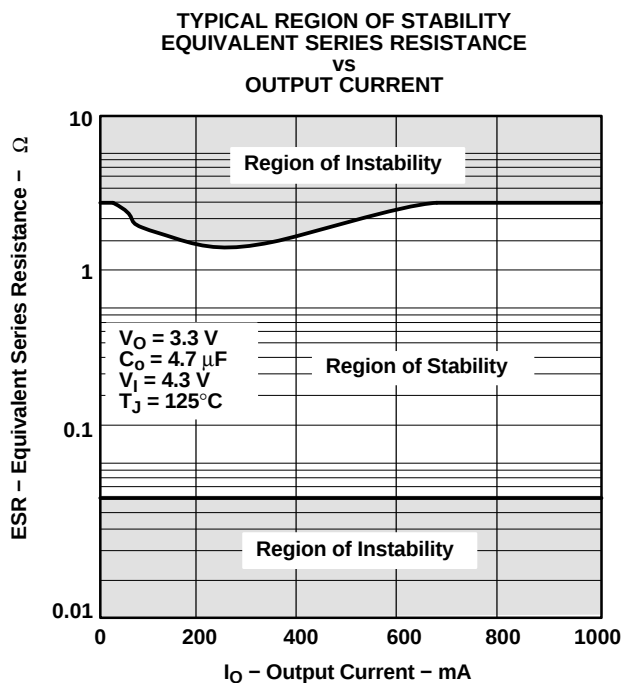


Figure 23.

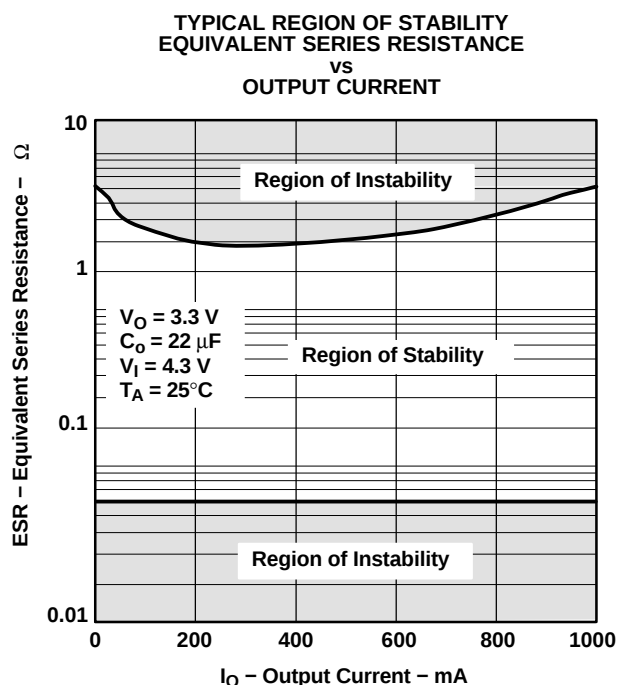


Figure 24.

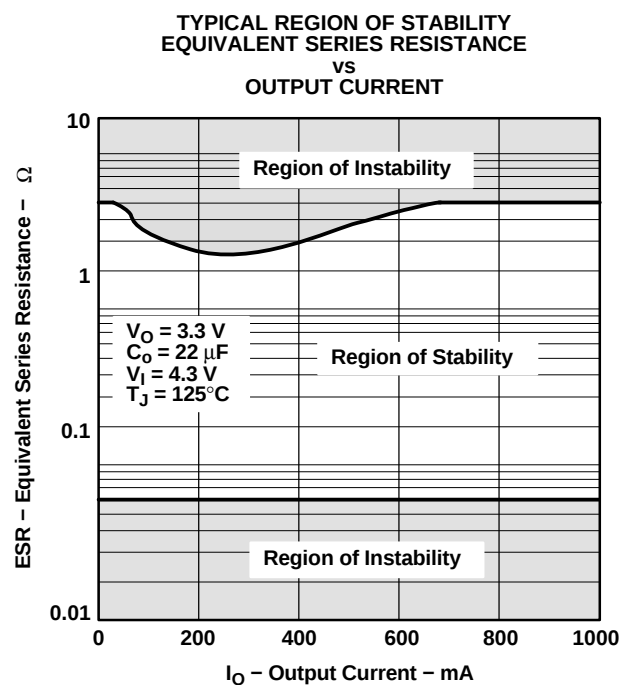


Figure 25.

## APPLICATION INFORMATION

The TPS768xx family includes eight fixed-output voltage regulators (1.5 V, 1.8 V, 2.5 V, 2.7 V, 2.8 V, 3.0 V, 3.3 V, and 5.0 V), and offers an adjustable device, the TPS76801 (adjustable from 1.2 V to 5.5 V).

### DEVICE OPERATION

The TPS768xx features very low quiescent current, which remains virtually constant even with varying loads. Conventional LDO regulators use a pnp pass element, the base current of which is directly proportional to the load current through the regulator ( $I_B = I_C/\beta$ ). The TPS768xx uses a PMOS transistor to pass current; because the gate of the PMOS is voltage driven, operating current is low and invariable over the full load range.

Another pitfall associated with the pnp-pass element is its tendency to saturate when the device goes into dropout. The resulting drop in  $\beta$  forces an increase in  $I_B$  to maintain the load. During power up, this translates to large start-up currents. Systems with limited supply current may fail to start up. In battery-powered systems, it means rapid battery discharge when the voltage decays below the minimum required for regulation. The TPS768xx quiescent current remains low even when the regulator drops out, eliminating both problems.

The TPS768xx family also features a shutdown mode that places the output in the high-impedance state (essentially equal to the feedback-divider resistance) and reduces quiescent current to 2  $\mu$ A. If the shutdown feature is not used,  $\overline{EN}$  should be tied to ground.

### MINIMUM LOAD REQUIREMENTS

The TPS768xx family is stable even at zero load; no minimum load is required for operation.

### FB - PIN CONNECTION (ADJUSTABLE VERSION ONLY)

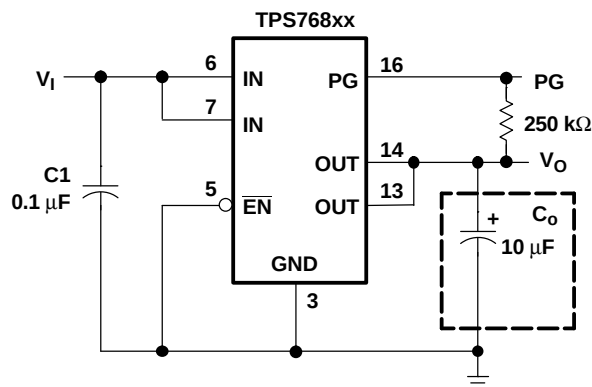
The FB pin is an input pin to sense the output voltage and close the loop for the adjustable option. The output voltage is sensed through a resistor divider network to close the loop as shown in Figure 27. Normally, this connection should be as short as possible; however, the connection can be made near a critical circuit to improve performance at that point. Internally, FB connects to a high-impedance wide-bandwidth amplifier and noise pickup feeds through to the regulator output. Routing the FB connection to minimize/avoid noise pickup is essential.

### EXTERNAL CAPACITOR REQUIREMENTS

An input capacitor is not usually required; however, a ceramic bypass capacitor (0.047  $\mu$ F or larger) improves load transient response and noise rejection if the TPS768xx is located more than a few inches from the power supply. A higher-capacitance electrolytic capacitor may be necessary if large (hundreds of milliamps) load transients with fast rise times are anticipated.

Like all low dropout regulators, the TPS768xx requires an output capacitor connected between OUT and GND to stabilize the internal control loop. The minimum recommended capacitance value is 10  $\mu$ F and the ESR (equivalent series resistance) must be between 60 m $\Omega$  and 1.5  $\Omega$ . Capacitor values 10  $\mu$ F or larger are acceptable, provided the ESR is less than 1.5  $\Omega$ . Solid tantalum electrolytic, aluminum electrolytic, and multilayer ceramic capacitors are all suitable, provided they meet the requirements described above. Most of the commercially available 10  $\mu$ F surface-mount ceramic capacitors, including devices from Sprague and Kemet, meet the ESR requirements stated above.

## APPLICATION INFORMATION (continued)



**Figure 26. Typical Application Circuit (Fixed Versions)**

The output voltage of the TPS76801 adjustable regulator is programmed using an external resistor divider as shown in Figure 27. The output voltage is calculated using:

$$V_O = V_{\text{ref}} \times \left(1 + \frac{R1}{R2}\right)$$

where:

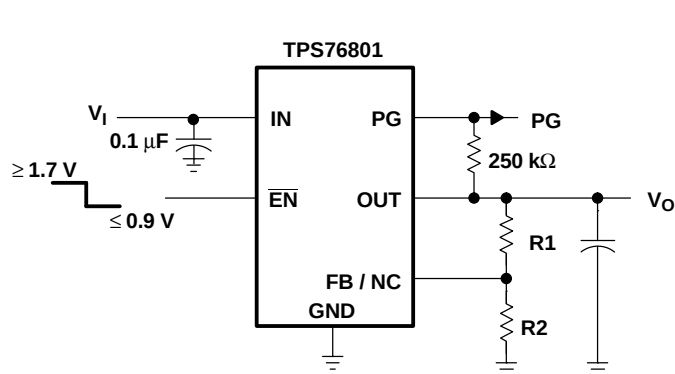
$$V_{\text{ref}} = 1.1834 \text{ V typ (the internal reference voltage)}$$

(1)

Resistors R1 and R2 should be chosen for approximately 50-μA divider current. Lower value resistors can be used but offer no inherent advantage and waste more power. Higher values should be avoided as leakage currents at FB increase the output voltage error. The recommended design procedure is to choose R2 = 30.1 kΩ to set the divider current at 50 μA and then calculate R1 using:

$$R1 = \left(\frac{V_O}{V_{\text{ref}}} - 1\right) \times R2$$

(2)



**Figure 27. TPS76801 Adjustable LDO Regulator Programming**

**OUTPUT VOLTAGE  
 PROGRAMMING GUIDE**

| OUTPUT VOLTAGE | R1   | R2   | UNIT |
|----------------|------|------|------|
| 2.5 V          | 33.2 | 30.1 | kΩ   |
| 3.3 V          | 53.6 | 30.1 | kΩ   |
| 3.6 V          | 61.9 | 30.1 | kΩ   |
| 4.75 V         | 90.8 | 30.1 | kΩ   |

## POWER-GOOD INDICATOR

The TPS768xx features a power-good (PG) output that can be used to monitor the status of the regulator. The internal comparator monitors the output voltage: when the output drops to between 92% and 98% of its nominal regulated value, the PG output transistor turns on, taking the signal low. The open-drain output requires a pullup resistor. If not used, it can be left floating. PG can be used to drive power-on reset circuitry or used as a low-battery indicator. PG does not assert itself when the regulated output voltage falls out of the specified 2% tolerance, but instead reports an output voltage low, relative to its nominal regulated value.

## APPLICATION INFORMATION (continued)

### REGULATOR PROTECTION

The TPS768xx PMOS-pass transistor has a built-in back diode that conducts reverse currents when the input voltage drops below the output voltage (e.g., during power down). Current is conducted from the output to the input and is not internally limited. When extended reverse voltage is anticipated, external limiting may be appropriate.

The TPS768xx also features internal current limiting and thermal protection. During normal operation, the TPS768xx limits output current to approximately 1.7 A. When current limiting engages, the output voltage scales back linearly until the overcurrent condition ends. While current limiting is designed to prevent gross device failure, care should be taken not to exceed the power dissipation ratings of the package. If the temperature of the device exceeds 150°C (typ), thermal-protection circuitry shuts it down. Once the device has cooled below 130°C (typ), regulator operation resumes.

### POWER DISSIPATION AND JUNCTION TEMPERATURE

Specified regulator operation is assured to a junction temperature of 125°C; the maximum junction temperature should be restricted to 125°C under normal operating conditions. This restriction limits the power dissipation the regulator can handle in any given application. To ensure the junction temperature is within acceptable limits, calculate the maximum allowable dissipation,  $P_{D(max)}$ , and the actual dissipation,  $P_D$ , which must be less than or equal to  $P_{D(max)}$ .

The maximum-power-dissipation limit is determined using the following equation:

$$P_{D(max)} = \frac{T_{Jmax} - T_A}{R_{\theta JA}}$$

where:

$T_{Jmax}$  is the maximum allowable junction temperature.

$R_{\theta JA}$  is the thermal resistance junction-to-ambient for the package, i.e., 172°C/W for the 8-terminal SOIC and 32.6°C/W for the 20-terminal PWP with no airflow.

$T_A$  is the ambient temperature. (3)

The regulator dissipation is calculated using:

$$P_D = (V_I - V_O) \times I_O \quad (4)$$

Power dissipation resulting from quiescent current is negligible. Excessive power dissipation will trigger the thermal protection circuit.

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TPS76801QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76801QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76801QDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76801QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76801QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76801QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76815QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76815QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76815QDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76815QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76815QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76815QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76818QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76818QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76818QDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76818QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76818QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76818QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76825QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76825QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76825QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76825QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76825QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76827QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76827QDG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TPS76827QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76827QDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76827QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76827QPWPG4   | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76827QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76827QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76828QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76828QDG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76828QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76828QDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76828QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76828QPWPG4   | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76828QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76828QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76830QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76830QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76830QDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76830QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76830QPWPG4   | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76830QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76830QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76833QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76833QDG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76833QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76833QDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76833QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TPS76833QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76833QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76850QD       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76850QDR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76850QDRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS76850QPWP     | ACTIVE                | HTSSOP       | PWP             | 20   | 70          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76850QPWPR    | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |
| TPS76850QPWPRG4  | ACTIVE                | HTSSOP       | PWP             | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

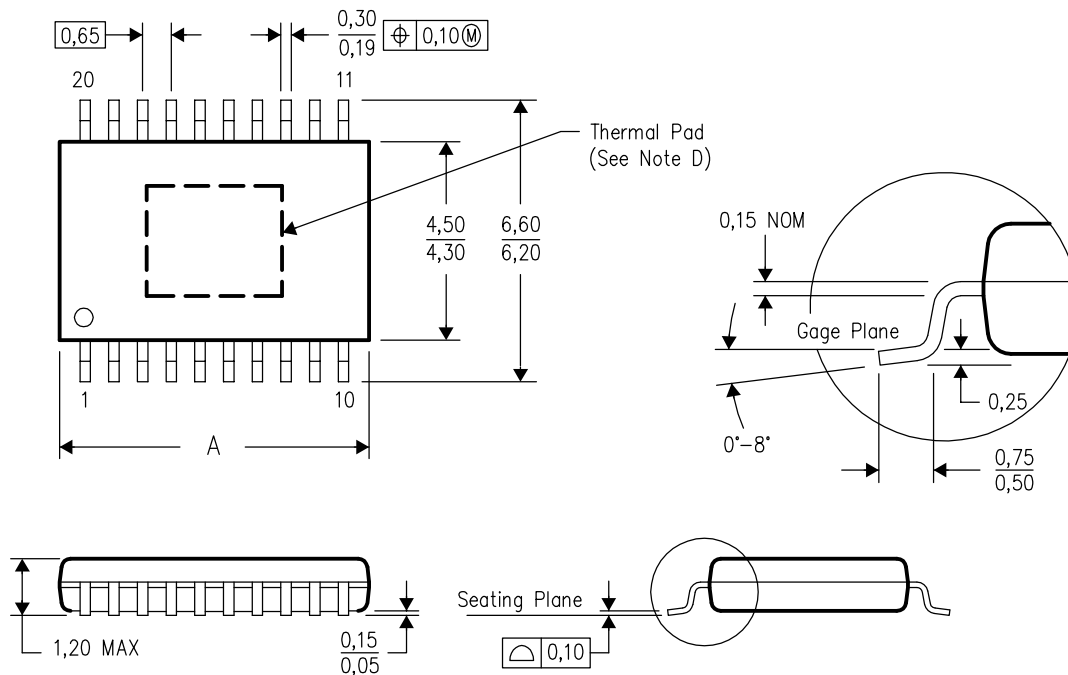
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## PWP (R-PDSO-G\*\*)

## PowerPAD™ PLASTIC SMALL-OUTLINE PACKAGE

20 PIN SHOWN

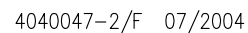


| PINS ** | 14   | 16   | 20   | 24   | 28   |
|---------|------|------|------|------|------|
| DIM     |      |      |      |      |      |
| A MAX   | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN   | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

4073225/G 08/03

- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusions.
  - This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - Falls within JEDEC MO-153

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A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
D. Falls within JEDEC MS-012 variation AA.

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